

<http://www.iccss.org/>

ICCSS 2019

2019 3rd International Conference on Circuits, System and Simulation

June 13-15, 2019

Southeast University Liu Yuan Hotel, Nanjing, China

2019 3rd International Conference on Circuits, System and Simulation (ICCSS 2019) will be held in Southeast University Liu Yuan Hotel, Nanjing, China during June 13-15, 2019. ICCSS 2019 is organized by International Joint Research Laboratory of Information Display and Visualization, Southeast University and Asia Society of Researchers.

Paper Publication M J D B U J P O

After a careful reviewing process, all accepted papers will be published in the Conference Proceedings by IEEE, and send to be reviewed by IEEE Conference Publication Program for included in IEEE Xplore and indexed by EI Compendex and Scopus, like the ICCSS 2018 & ICCSS 2017.

Prof. Baoping Wang, executive president of Southeast University, China

Prof. Tayeb Mohammed-Brahim, University of Rennes 1, France, Southeast University, China

Organizing Committees P N N J U U F F T

Prof. Wei Lei, Southeast University, China
Dr. Qasim Khan, Southeast University, China
Dr. Mohd Nazim Bin Mohtar, University Putra Malaysia, Malaysia

Submission Papers 1 B Q F S T

- Advanced Technologies (Nano, MEMS)
- Assembly and Packaging
- Circuit simulation & modeling
- Biomedical Circuits and System
- Digital Communication
- Digital Circuits and Signal Processing
- Information and scientific visualization
- Neural Network Circuits and Systems
- Simulation Application in Industry
- Device Simulation & modeling
- RF and Wireless Circuits and Systems
- Simulation and Modeling in Molecular Biology
- Systems Architectures and Applications
- Telecommunication and Multimedia
- High Performance Computing & Simulation

More topics, please visit: <http://www.iccss.org/cfp.html>

Important Dates U % B U F T

- Submission Deadline: March 10, 2019
- Notification Date: April 5, 2019
- Registration Deadline: April 20, 2019

Submission Methods . F U I P E T

- Please log in Easychair to submit your paper or abstract by the link (<http://www.easychair.org/conferences/?conf=iccss2019>)
- You could submit by email directly (Email: iccss@asr.org.)

Organized By:



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SPROUBD

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ICCSS 2019

2019年第三届电路，系统与仿真国际会议

2019年6月13-15

中国南京·东南大学榴园宾馆

2019年第三届电路，系统与仿真国际会议将于2019年6月13-15日在中国南京·东南大学榴园宾馆召开。本次大会主要围绕电路，系统与仿真研究领域展开讨论，旨在为相关研究方向的专家学者及企业发展人提供一个分享研究成果、讨论存在的问题与挑战、探索前沿科技的国际性合作交流平台。现热忱欢迎从事相关技术研究的专家、学者和专业技术人员踊跃投稿并参加大会。

会议出版

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挑会主席

王保平 教授/常务副校长, 东南大学

Tayeb Mohammed-Brahim 教授, 法国雷恩第一大学/东南大学

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Mohd Nazim Bin Mohtar 博士, 马来西亚博特拉大学

会议征稿主题

- 先进技术 (Nano , MEMS)
- 组装和包装
- 电路仿真和建模
- 数字通信
- 神经网络电路和系统
- 数字电路和信号处理
- 信息和科学可视化
- 射频和无线电路和系统
- 分子生物学的模拟和建模
- 系统架构和应用程序

更多征稿主题, 请访问: <http://www.iccss.org/cfp.html>

会议重要时间

- 投稿截止日: 2019年3月10日
- 注册截至日: 2019年4月20日
- 录用通知: 2019年4月5日

投稿方式

- 请登录Easychair投稿系统投稿(<http://www.easychair.org/conferences/?conf=iccss2019>)
- 邮箱投稿 (Email: iccss@asr.org)

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联系方式

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